

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE	
<u>In re application of:</u> Tien-Jen Cheng	<u>Filed:</u> 07/31/2003
	<u>Examiner:</u> Nathan Ha
<u>Serial No.</u> 10/604,378 10 604,578	<u>Group Art Unit:</u> 2914
<u>Title:</u> Encapsulated Pin Structure for Improved Reliability of Wafer	<u>Docket #:</u> FIS920030103US1

AMENDMENT

Commissioner of Patents & Trademarks
Alexandria, VA 22313

Sir:

Responsive to the Restriction Requirement of 07/25/2005, please amend the above identified application as follows: